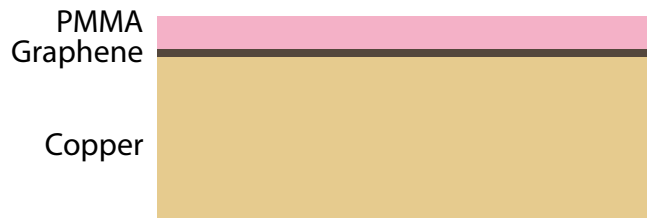




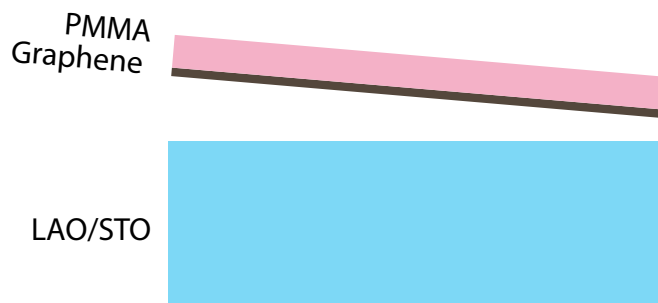
(a) CVD growth on copper



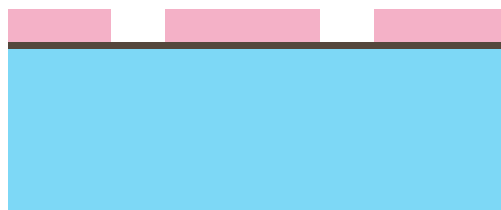
(b) PMMA spin coating



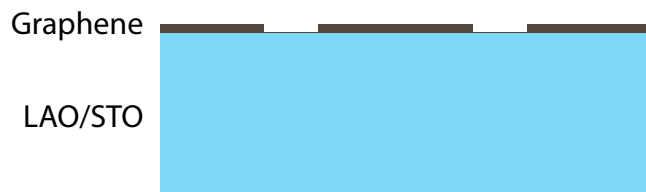
(c) Copper etching



(d) Transferring onto LAO/STO



(e) Deep-UV photolithography



(f) Oxygen plasma etching;  
remove PMMA